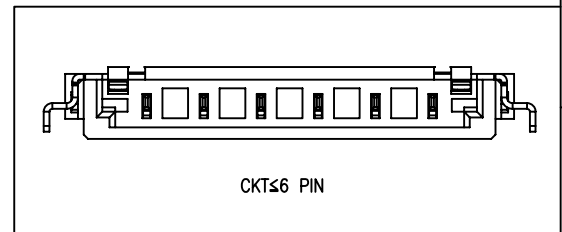


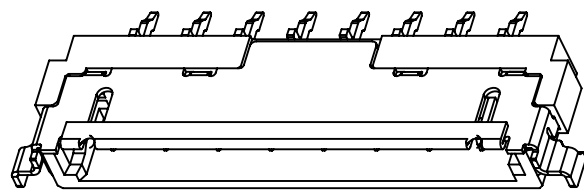
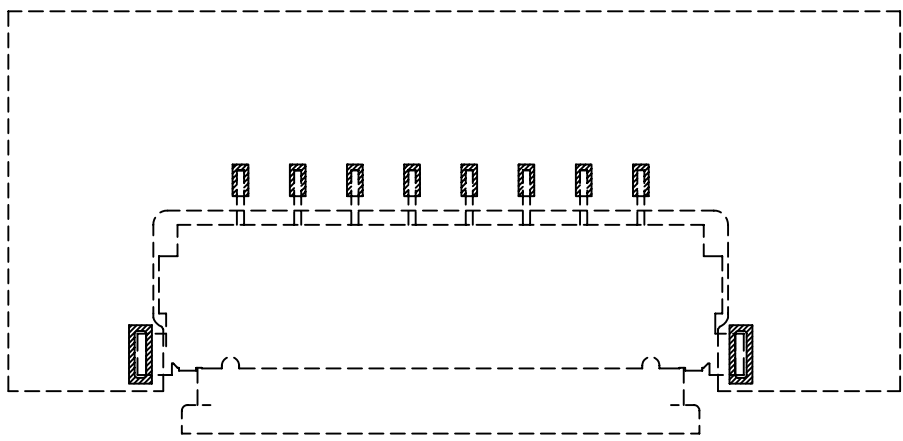
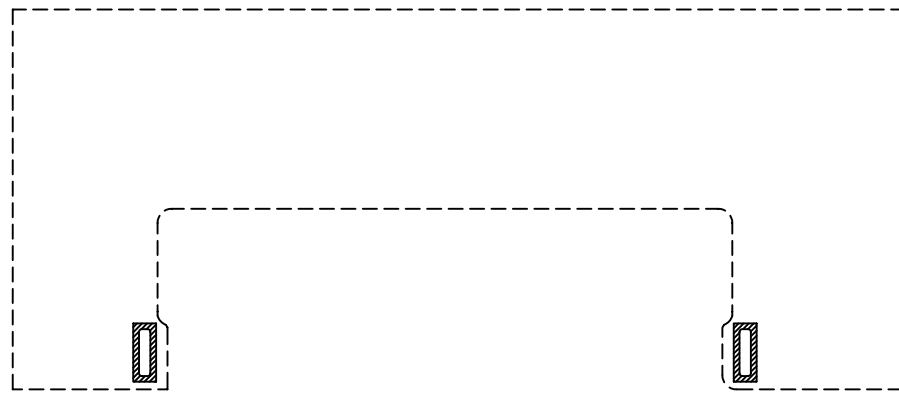
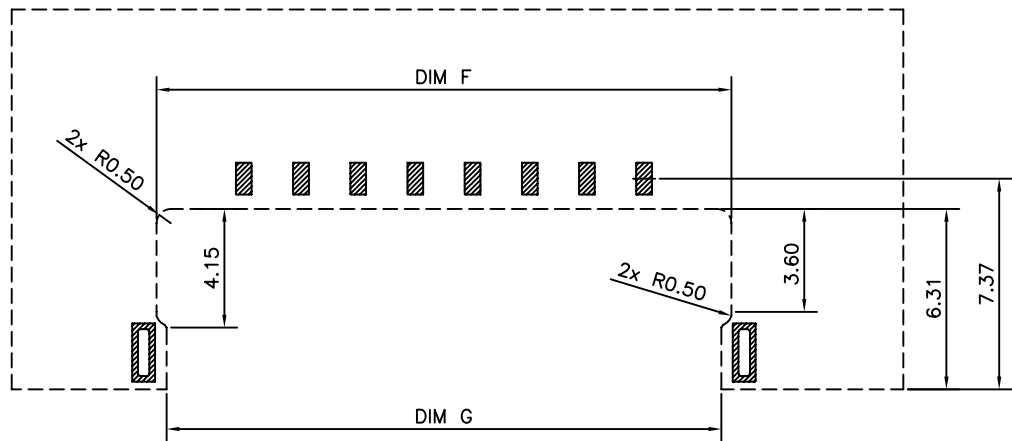
- NOTES:
- MATERIAL:
 - HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR: BLACK.
 - CONTACT: COPPER ALLOY
 - SHELL: COPPER ALLOY
 - FINISH: CONTACT:
 - GOLD FLASH
 - 50~100u" NICKEL UNDERPLATING OVERALL.
 - REFLOW SOLDER CAPABLE TO 260°C PER ACES SPEC.
 - SPEC. PLS. REFER TO SPEC-50458-XXXX-XXX
 - PACKAGE PLS. SEE P/N

6. PART NUMBER
- 50477-XXX X X-XXX
- | TYPE | DIM A | PACKAGE |
|------|-------|--------------------|
| 001 | 1.20 | 50477-XXXXX-TRP |
| 002 | 1.50 | 50477-XXXXX-05-TRP |
| 003 | 1.20 | 50477-XXXXX-01-TRP |
- NO OF CKT PLATING
0: TAPE & REEL 1. GOLD FLASH



CKT	DIM B	DIM C	DIM D	DIM E
6	10.00	15.70	17.20	12.20
7	12.00	17.70	19.20	14.20
8	14.00	19.70	21.20	16.20
10	18.00	23.70	25.20	20.20

一般公差 TOLERANCES X ±0.5 .XX ±0.15 X ±0.25 .XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronic Co.,Ltd.	
檢驗尺寸標示 SYMBOLS ⊕ ⊕ INDICATE CLASSIFICATION DIMENSION ⊕ MARK IS CRITICAL DIM. ⊕ MARK IS MAJOR DIM.	品名 (TITLE) 2.0MM WTB WAFER CONN. SMT R/A TYPE 圖號 (DWG.NO) 50477-XXXXX-XXX	製圖 (DR) 12/06/14 審核 (CHKD) SAM 核准 (APPD) JASON	BRAVE SAM JASON
表面處理 (FINISH)	比例 (SCALE) 4:1 單位 (UNITS) mm		張數 (SHEET) 1 OF 2 尺寸 (SIZE) A4 版次 (REV) A



CKT	DIM F	DIM G
6	16.10	15.40
7	18.10	17.40
8	20.10	19.40
10	24.10	23.40

一般公差 TOLERANCES X ±0.5 .XX ±0.15 X ±0.25 .XXX ±0.1 ANGLES ±2°		宏致電子股份有限公司 Aces Electronic Co.,Ltd.	
檢驗尺寸標示 SYMBOLS (C) (M) INDICATE CLASSIFICATION DIMENSION (C) MARK IS CRITICAL DIM. (M) MARK IS MAJOR DIM.	品名 (TITLE) 2.0MM WTB WAFER CONN. SMT R/A TYPE 圖號 (DWG.NO) 50477-XXXXX-XXX	製圖 (DR) 12/06/14 審核 (CHKD) SAM 核准 (APPD) JASON	BRAVE SAM JASON
表面處理 (FINISH)	比例 (SCALE) 4:1 單位 (UNITS) mm		張數 (SHEET) 2 OF 2 尺寸 (SIZE) A4 版次 (REV) A

单击下面可查看定价，库存，交付和生命周期等信息

[>>ACES\(宏致\)](#)